



XTMT03N95D

30V N-Channel MOSFET

Product Description

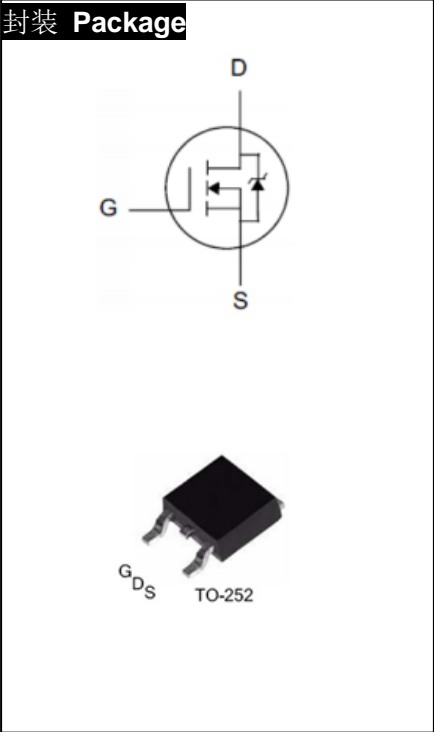
BV_{DSS}	30	V
I_D	95	A
$R_{DS(ON),Typ.}$	3.7	mΩ

General Features

- Proprietary New Planar Technology
- $R_{DS(ON),typ.}=3.7\text{ m}\Omega@V_{GS}=10V$
- Fast Recovery Body Diode
- Low Gate Charge Minimize Switching Loss

Applications

- Synchronous Rectification
- UPS Inverter



Device	Package	Marking
XTMT03N95D	TO-252	XTMT03N95D

Absolute Maximum Ratings $T_j=25^{\circ}\text{C}$

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-to-Source Voltage	30	V
V_{GSS}	Gate-to-Source Voltage	± 20	
I_D	Continuous Drain Current	95	A
I_{DM}	Pulsed Drain Current at $V_{GS}=10V$	380	
E_{AS}	Single Pulse Avalanche Energy	150	mJ
P_D	Power Dissipation	100	W
T_L	Soldering Temperature Distance of 1.6mm from case for 10 seconds	300	$^{\circ}\text{C}$
$T_J \& T_{STG}$	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the “Absolute Maximum Ratings” may cause permanent damage to the device.



Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.5	$^{\circ}\text{C/W}$

Electrical Characteristics $T_j=25^{\circ}\text{C}$

OFF Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
BV_{DSS}	Drain-to-Source Breakdown Voltage	30	-	-	V	$V_{GS}=0V, I_D=250\mu A$
I_{DSS}	Drain-to-Source Leakage Current	-	-	1	μA	$V_{DS}=30V, V_{GS}=0V$
		-	-	100		$V_{DS}=24V, V_{GS}=0V, T_J=125^{\circ}\text{C}$
I_{GSS}	Gate-to-Source Leakage Current	-	-	+100	nA	$V_{GS}=+20V, V_{DS}=0V$
		-	-	-100		$V_{GS}=-20V, V_{DS}=0V$

ON Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
$R_{DS(ON)}$	Static Drain-to-Source On-Resistance	-	3.7	4.4	$m\Omega$	$V_{GS}=10V, I_D=20A$
		-	5.5	7.5	$m\Omega$	$V_{GS}=4.5V, I_D=15A$
$V_{GS(TH)}$	Gate Threshold Voltage	1.0	1.5	2.2	V	$V_{DS}=V_{GS}, I_D=250\mu A$



Dynamic Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
C_{iss}	Input Capacitance	-	1784	-	pF	$V_{GS}=0V$, $V_{DS}=15V$, $f=1.0MHz$
C_{rss}	Reverse Transfer Capacitance	-	212	-		
C_{oss}	Output Capacitance	-	266	-		
Q_g	Total Gate Charge	-	38.4	-	nC	$V_{DD}=15V$, $I_D=20A$, $V_{GS}=0$ to 10V
Q_{gs}	Gate-to-Source Charge	-	5.8	-		
Q_{gd}	Gate-to-Drain (Miller) Charge	-	7.9	-		

Resistive Switching Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
$t_{d(ON)}$	Turn-on Delay Time	-	7	-	ns	$V_{DD}=5V$, $I_D=20A$, $V_{GS}=10V$ $R_g=6\Omega$
t_{rise}	Rise Time	-	6	-		
$t_{d(OFF)}$	Turn-Off Delay Time	-	30	-		
t_{fall}	Fall Time	-	8	-		

Source-Drain Body Diode Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
I_{SD}	Continuous Source Current ^[1]	-	-	95	A	Integral pn-diode in MOSFET
I_{SM}	Pulsed Source Current ^[1]	-	-	380		
V_{SD}	Diode Forward Voltage	-	-	1.2	V	$I_S=20A$, $V_{GS}=0V$
t_{rr}	Reverse Recovery Time	-	47	-	ns	$V_{GS}=15V$ $I_F=20A$, $di_F/dt=100A/\mu s$
Q_{rr}	Reverse Recovery Charge	-	25	-	uC	

[1] Pulse width $\leq 380\mu s$; duty cycle $\leq 2\%$



Typical Characteristics

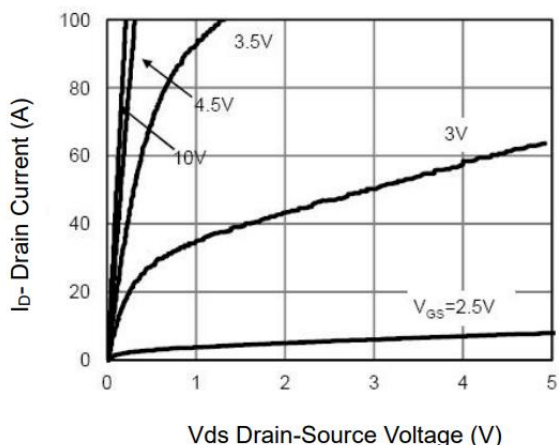


Figure 1 Output Characteristics

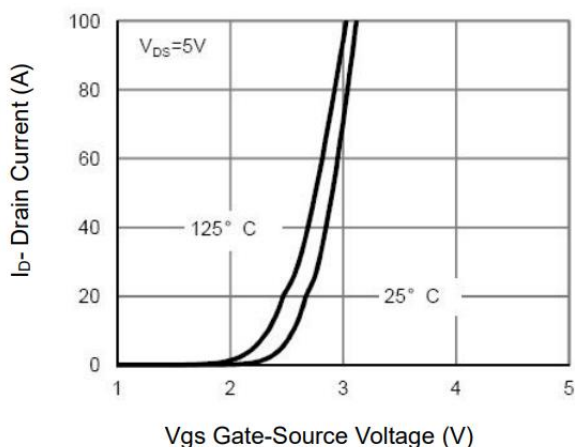


Figure 2 Transfer Characteristics

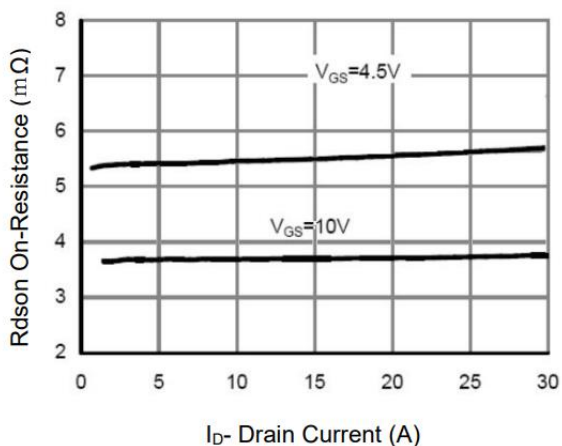


Figure 3 $R_{DS(on)}$ - Drain Current

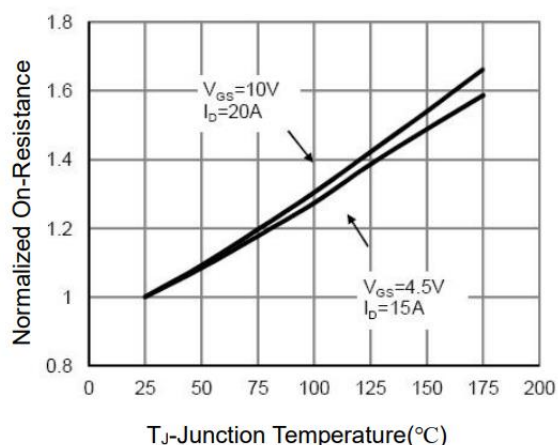


Figure 4 $R_{DS(on)}$ -Junction Temperature

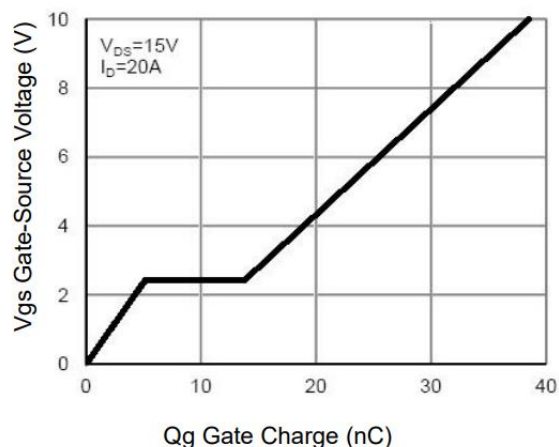


Figure 5 Gate Charge

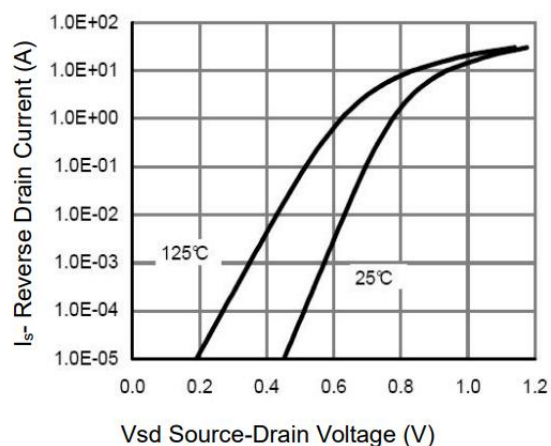


Figure 6 Source- Drain Diode Forward



Typical Characteristics

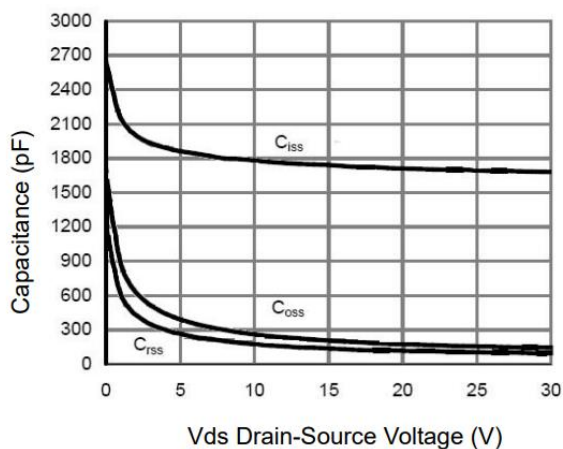


Figure 7 Capacitance vs Vds

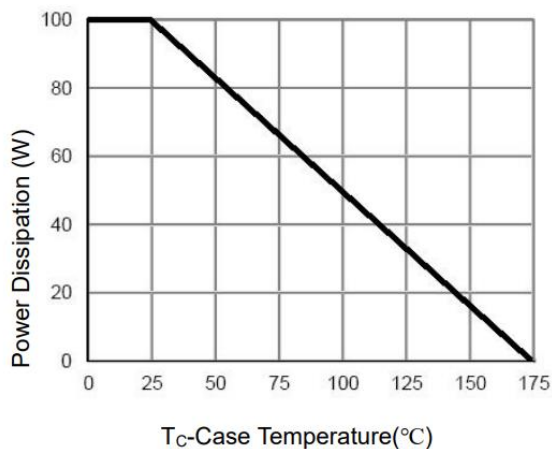


Figure 9 Power De-rating

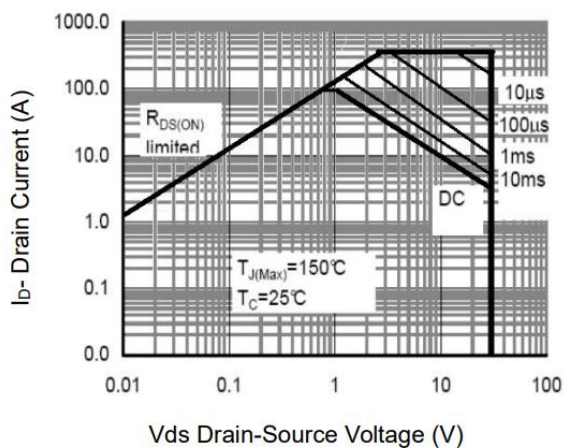


Figure 8 Safe Operation Area

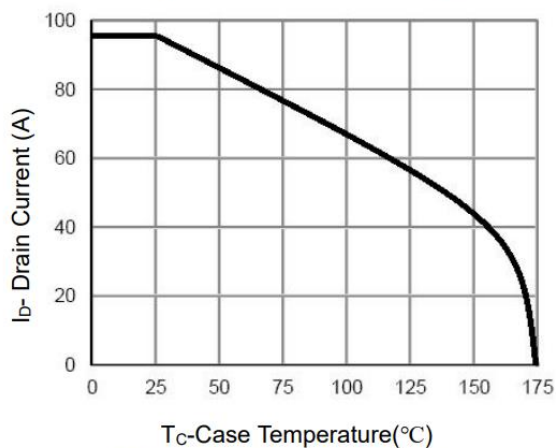


Figure 10 Current De-rating

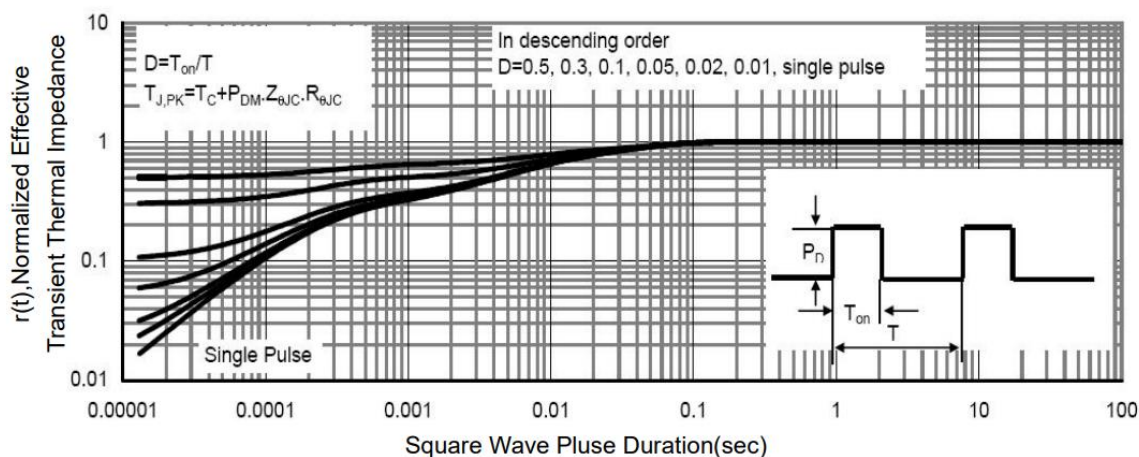


Figure 11 Normalized Maximum Transient Thermal Impedance



Test Circuits and Waveforms

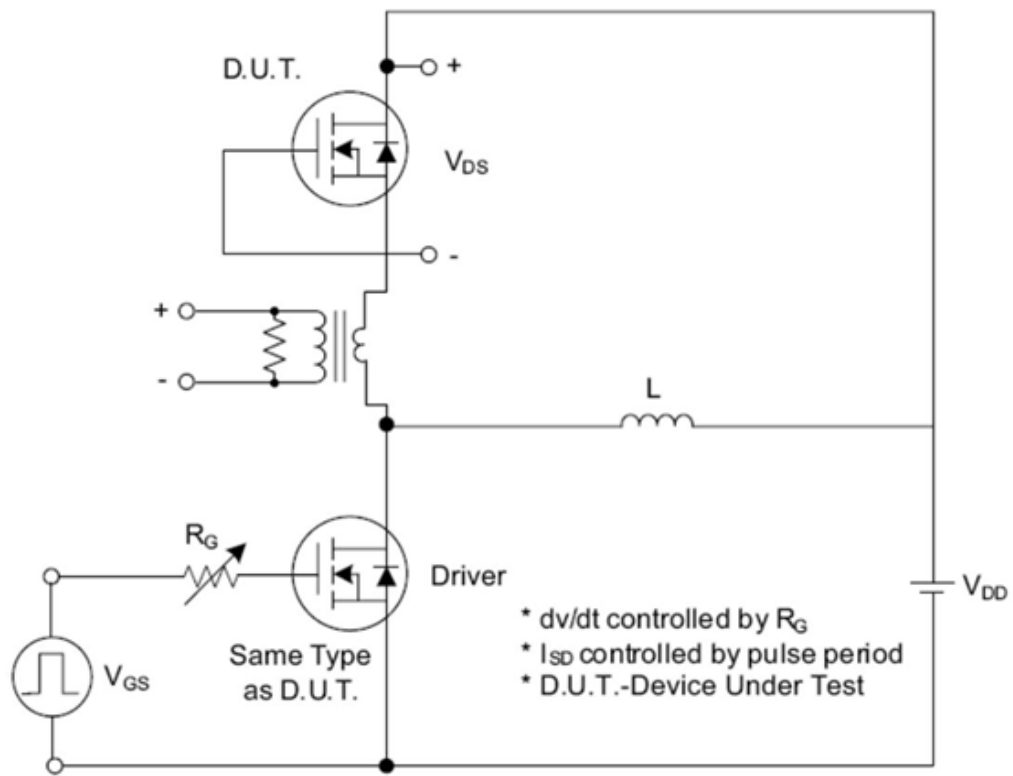


Fig. 1.1 Peak Diode Recovery dv/dt Test Circuit

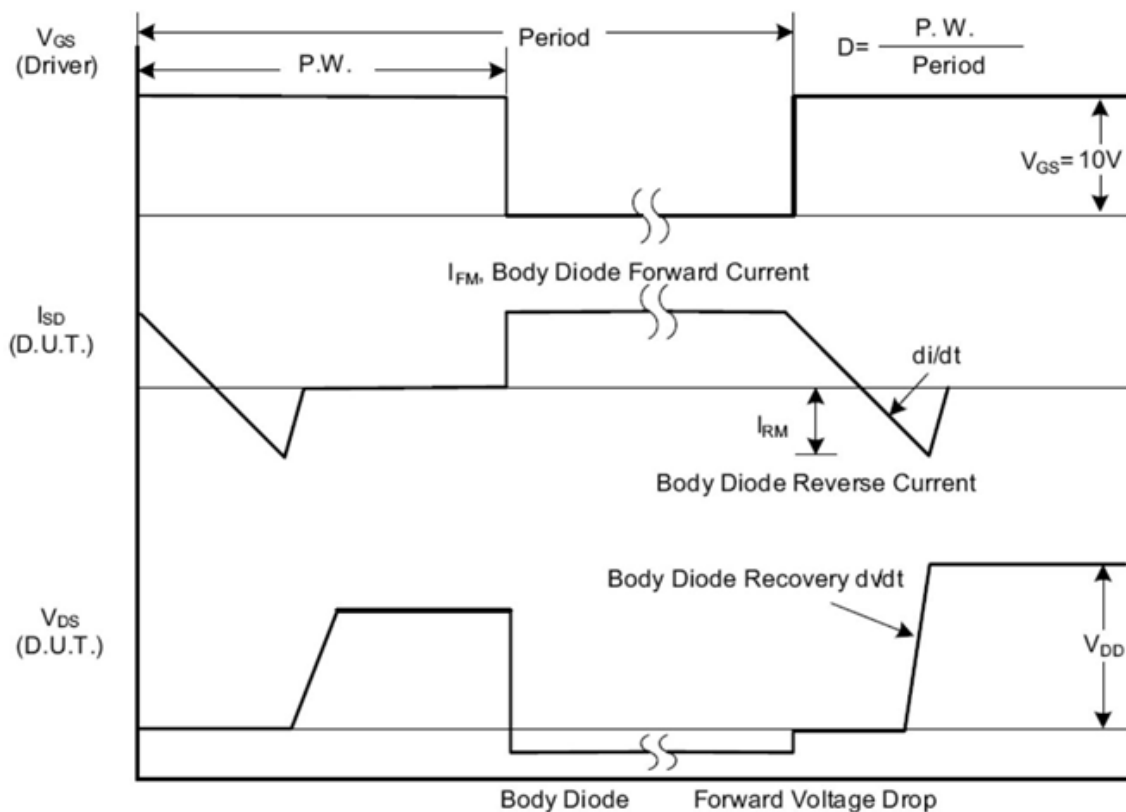


Fig. 1.2 Peak Diode Recovery dv/dt Waveforms



Test Circuits and Waveforms (Cont.)

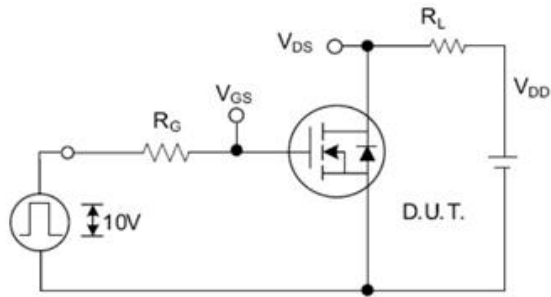


Fig. 2.1 Switching Test Circuit

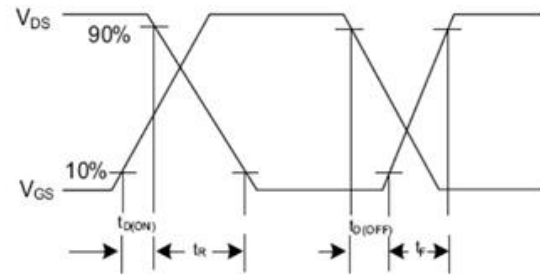


Fig. 2.2 Switching Waveforms

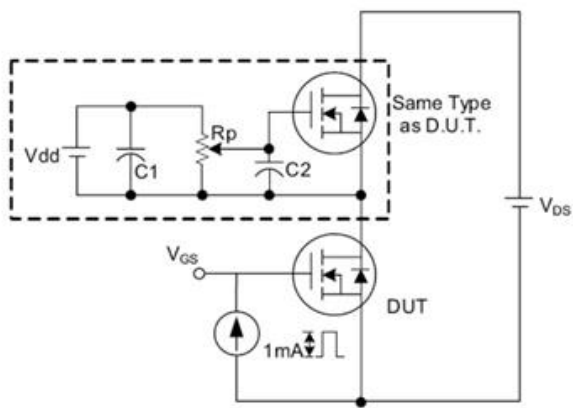


Fig. 3.1 Gate Charge Test Circuit

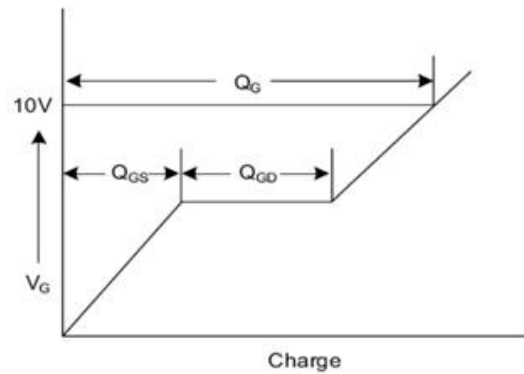


Fig. 3.2 Gate Charge Waveform

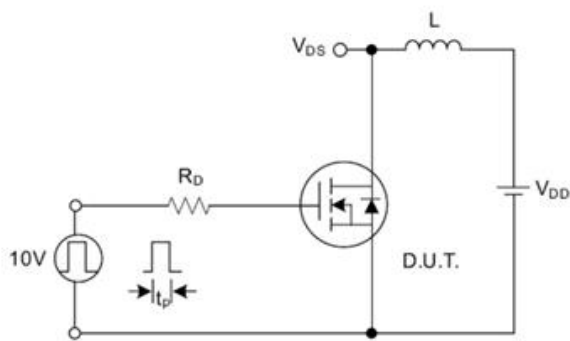


Fig. 4.1 Unclamped Inductive Switching Test Circuit

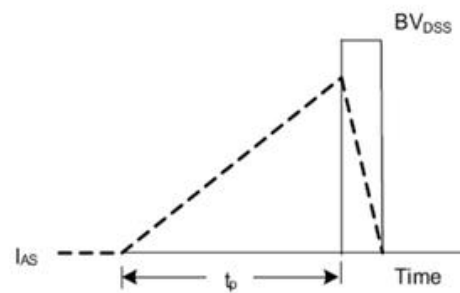


Fig. 4.2 Unclamped Inductive Switching Waveforms